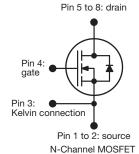
COMPLIANT

HALOGEN

FREE



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.092		
Q _g max. (nC)	51			
Q _{gs} (nC)	16			
Q _{gd} (nC)	8			
Configuration	Single			

FEATURES

- 4th generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8LR
Lead (Pb)-free and halogen-free	SiHR100N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V_{DS}	600		
Gate-source voltage			V_{GS}	± 30	V	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	I _D	38	А	
	V _{GS} at 10 V	T _C = 100 °C		24		
Pulsed drain current ^a			I _{DM}	65		
Linear derating factor				2.8	W/°C	
Single pulse avalanche energy b			E _{AS}	173	mJ	
Maximum power dissipation			P _D	347	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		dv/dt	100	V/ns	
Reverse diode dv/dt ^d		uv/ut	12] v/ns		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. $V_{DD} = 120 \text{ V}$, starting $T_J = 25 \,^{\circ}\text{C}$, $L = 28.2 \,\text{mH}$, $R_g = 25 \,\Omega$, $I_{AS} = 3.5 \,\text{A}$
- c. 1.6 mm from case

S24-1138-Rev. C, 04-Nov-2024

d. $I_{SD} \le I_D$, di/dt = 100 A/ μ s, starting T_J = 25 °C



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R _{thJA}	=	42	°C/W	
Maximum junction-to-case (drain)	R_{thJC}	-	0.36	C/VV	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		-					
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.61	_	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3.0	-	5.0	V
	I _{GSS}	,	$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-source leakage		,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
Zava gata valtaga dyain avyyant		$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 13 A	-	0.092	0.105	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} = 8 V, I _D = 13 A		-	15	-	S
Dynamic							
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	2229	-	pF
Output capacitance	C _{oss}		$V_{DS} = 100 \text{ V},$		86	-	
Reverse transfer capacitance	C _{rss}	f = 100 kHz		-	2	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V 0VV 400V V 0V		-	91	-	
Effective output capacitance, time related ^b	C _{o(tr)}	V _{DS} = 0 \	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		544	-	
Total gate charge	Qg			-	34	51	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 13 \text{ A}, V_{DS} = 480 \text{ V}$		16	-	nC
Gate-drain charge	Q _{gd}				8	-	
Turn-on delay time	t _{d(on)}			-	25	50	- ns
Rise time	t _r	V _{DD} =	$V_{DD} = 480 \text{ V}, I_{D} = 13 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		43	86	
Turn-off delay time	t _{d(off)}	V _{GS} =			36	72	
Fall time	t _f			-	27	54	
Gate input resistance	R_g	f = 1 MHz		0.3	0.6	1.2	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	Is	showing the	MOSFET symbol showing the		-	38	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	65	- A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 13 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 13 \text{A},$ $di/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	321	642	ns
Reverse recovery charge	Q _{rr}			-	4.2	8.4	μC
Reverse recovery current	I _{RRM}			_	22	-	A



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

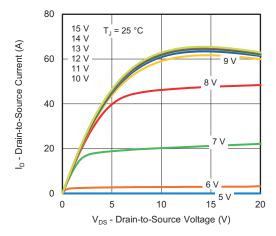


Fig. 1 - Typical Output Characteristics

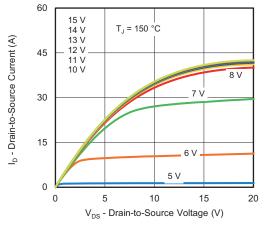


Fig. 2 - Typical Output Characteristics

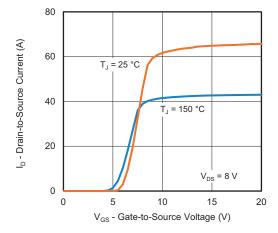


Fig. 3 - Typical Transfer Characteristics

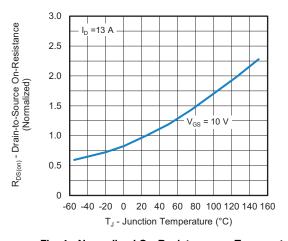


Fig. 4 - Normalized On-Resistance vs. Temperature

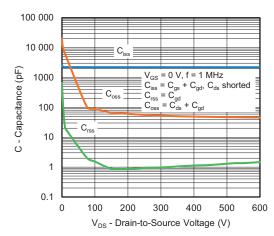


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

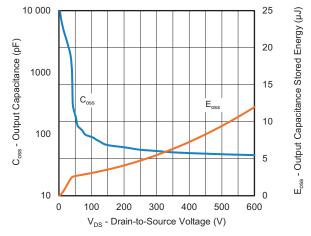


Fig. 6 - Coss and Eoss vs. VDS



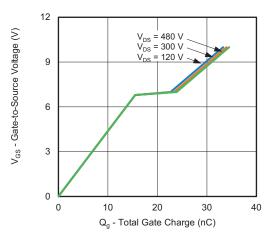


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

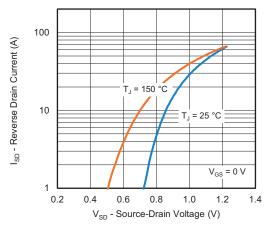


Fig. 8 - Typical Source-Drain Diode Forward Voltage

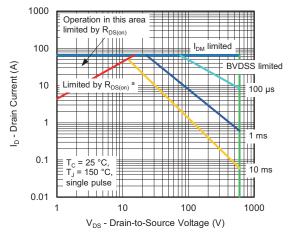


Fig. 9 - Maximum Safe Operating Area



a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

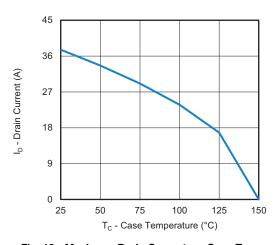


Fig. 10 - Maximum Drain Current vs. Case Temperature

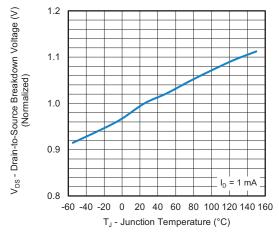


Fig. 11 - Temperature vs. Drain-to-Source Voltage



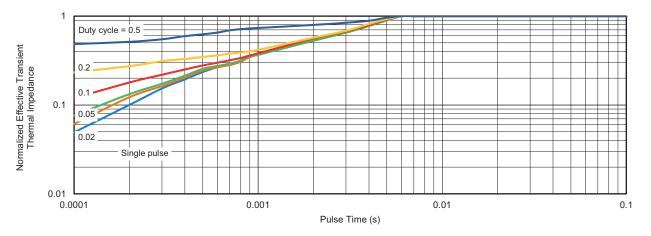


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

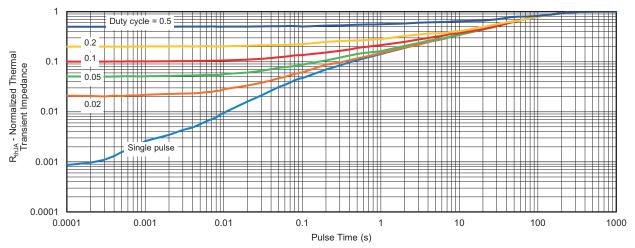


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

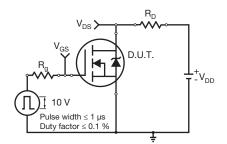


Fig. 14 - Switching Time Test Circuit

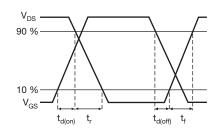


Fig. 15 - Switching Time Waveforms



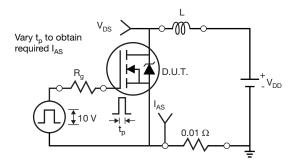


Fig. 16 - Unclamped Inductive Test Circuit

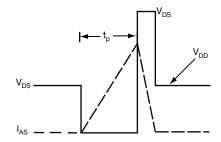


Fig. 17 - Unclamped Inductive Waveforms

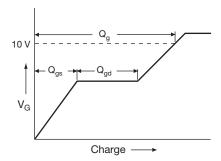


Fig. 18 - Basic Gate Charge Waveform

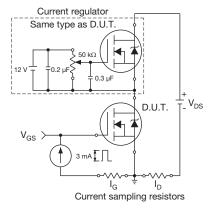
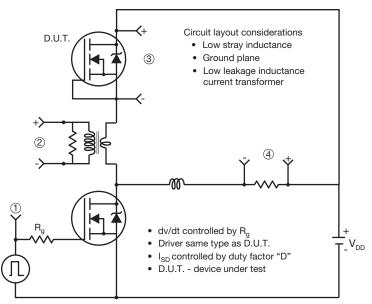


Fig. 19 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



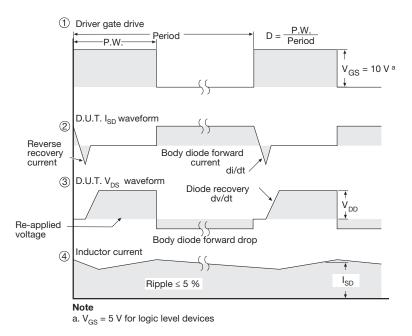
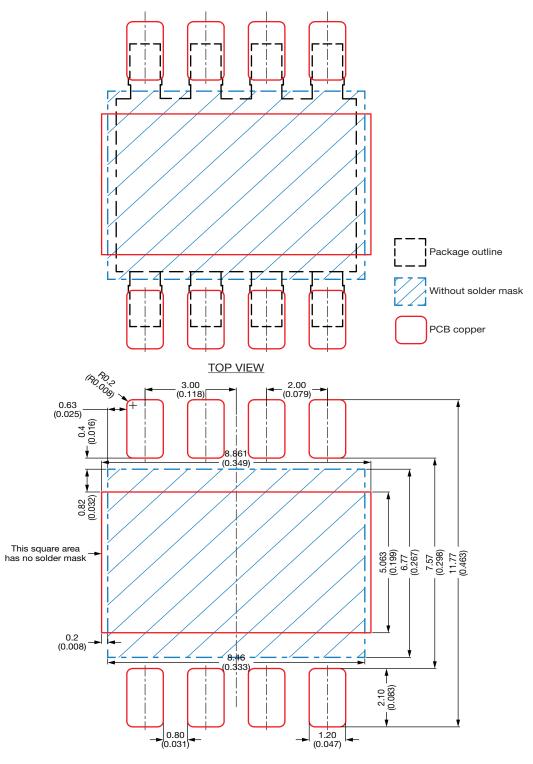


Fig. 20 - For N-Channel

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Recommended Land Pattern PowerPAK® 8 x 8LR



Notes

- This land pattern is for reference
- Proposed stencil thickness 200 µm All dimensions are in millimeter (inches)

ECN: S23-1106-Rev. A, 11-Dec-2023

DWG: 3022

Revision: 11-Dec-2023 Document Number: 92534



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